

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

APT 2814
JW

Applicant: Intel Corporation et al.

Title: POLYMERIC ENCAPSULATION MATERIAL WITH FIBROUS FILLER FOR USE IN
MICROELECTRONIC CIRCUIT PACKAGING

Docket No.: 884.415US1

Serial No.: 09/854,539

Filed: May 14, 2001

Due Date: December 9, 2005

Examiner: Ginette Peralta

Group Art Unit: 2814



MS Amendment

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

We are transmitting herewith the following attached items (as indicated with an "X"):

Return postcard.
 Response Under 37 CFR 1.111 (10 pgs.).

If not provided for in a separate paper filed herewith, Please consider this a PETITION FOR EXTENSION OF TIME for sufficient number of months to enter these papers and please charge any additional fees or credit overpayment to Deposit Account No. 19-0743.

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

Customer Number 21186

By: Ann M. McCrackin

Atty: Ann M. McCrackin

Reg. No. 42,858

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: MS Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this 9th day of November, 2005.

CAROLYN HULSEY
Name

Carol H
Signature

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.
(GENERAL)



S/N 09/854,539

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:	Intel Corporation et al.	Examiner:	Ginette Peralta
Serial No.:	09/854,539	Group Art Unit:	2814
Filed:	May 14, 2001	Docket No.:	884.415US1
Title:	POLYMERIC ENCAPSULATION MATERIAL WITH FIBROUS FILLER FOR USE IN MICROELECTRONIC CIRCUIT PACKAGING		
Assignee:	Intel Corporation	Customer No.:	21186

RESPONSE UNDER 37 C.F.R. 1.116

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

In response to the Office Action mailed September 9, 2005, please consider the remarks
as follows: